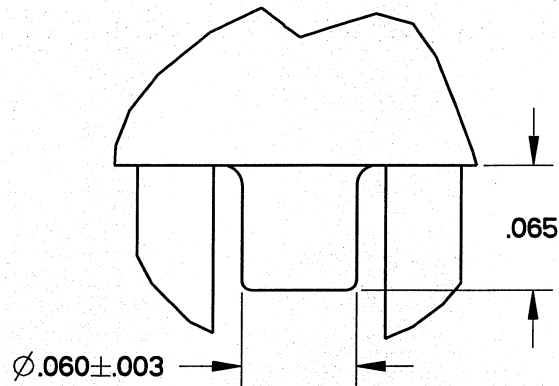
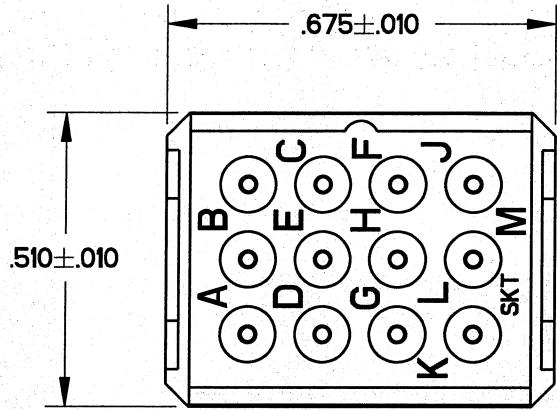
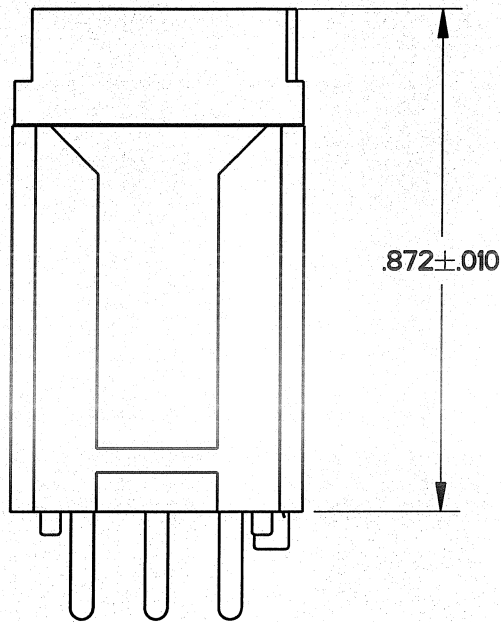
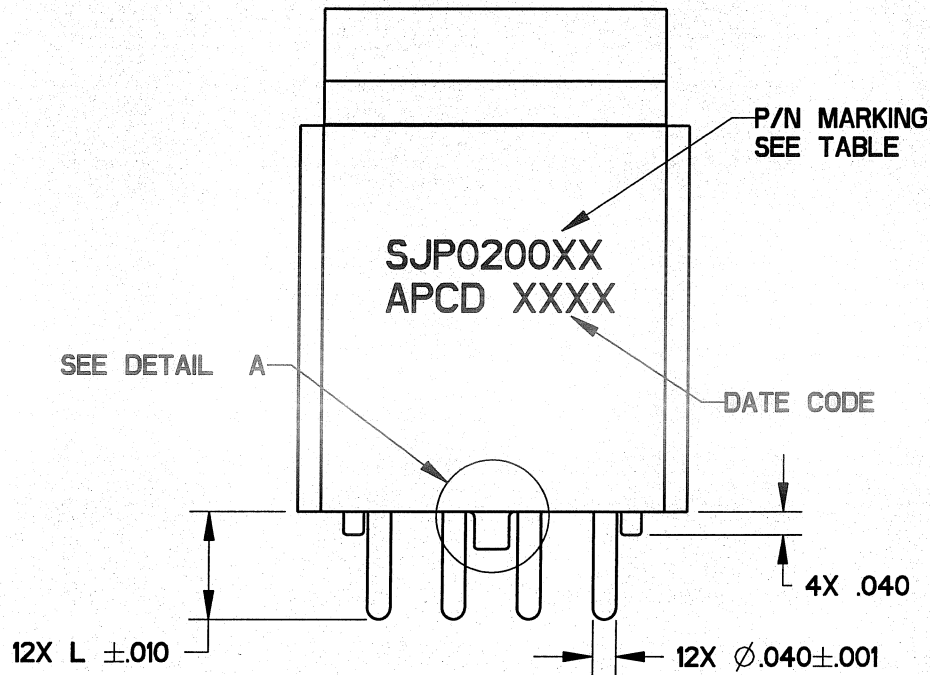
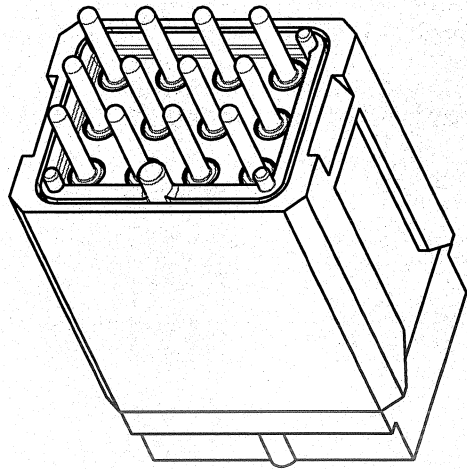
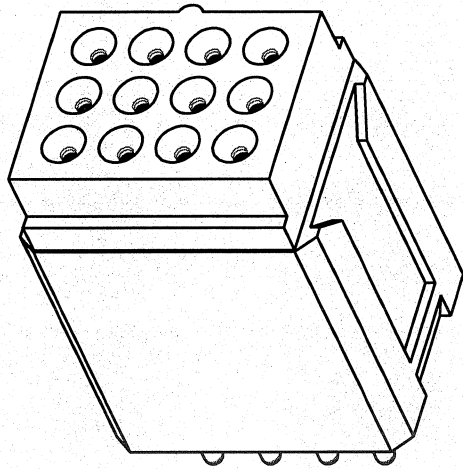


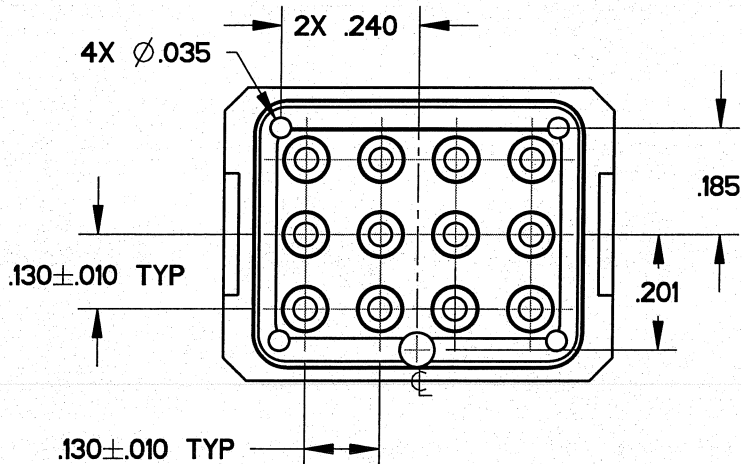
REV	ECN	APP'D
-	5873	JT 7/31/06
A	6062	JT 4/27/07
B	6070	JT 5-21-07
C	6166	JT 12/26/07
D	6167	JT 1/4/08
E	6221	JT 5/23/08
F	6246	8/11/08



DETAIL A
SCALE 10:1



- NOTES:
- MATERIALS:
BODY: POLYETHERIMIDE PER MIL-P-46184, VIRGIN MATERIAL ONLY.
GROMMET: SILICONE BLEND ELASTOMER.
CONTACT RETAINERS: STAINLESS STEEL.
INTERNAL/EXTERNAL PIN CONTACTS: COPPER ALLOY, HARD GOLD PLATE PER MIL-DTL-45204.
 - MODULE ACCEPTS M39029/22-192 CONTACT AND MS27488-20 SEALING PLUG.
 - INSULATION RESISTANCE: 5000 MEGAOHMS MIN AT 25°C



PART NO.	CONTACTS SUPPLIED	LENGTH "L"	P/N MARKING
SJP020000	M39029/22-192, QTY 13	.187	SJP020000
SJP020001	NONE		
SJP020010	M39029/22-192, QTY 13	.250	SJP020010
SJP020011	NONE		

DIMENSIONS ANSI Y14.5M UNITS: INCHES Pro/E FILE	TOLERANCES .XX ±0.01 .XXX ±0.005 ANGLES ±2.0°	PROJECTION 	Amphenol Pcd SPECIFICATION DRAWING		TITLE SOCKET MODULE, SJP PC MOUNT SIZE 20			
ORIGINAL THIS DOCUMENT CONTAINS PROPRIETARY INFORMATION WHICH IS THE CONFIDENTIAL PROPERTY OF AMPHENOL PCD, BEVERLY, MA			DRWN R. SWAINE 7/28/06	ENGR 8/11/08	SIZE B	DWG NO. SJP020000_C		REV F
			APPD 8/11/08		CODE: 58982		SCALE: 2:1	SHEET 1 OF 1